

SEMITOP® 2

Antiparallel Thyristor Module

SK 25 WT

Preliminary Data

Features

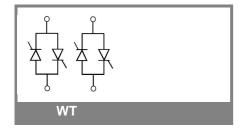
- Compact Design
- · One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DBC)
- · Glass passived thyristor chips
- Up to 1600V reverse voltage
- UL recognized, file no. E 63 532

Typical Applications

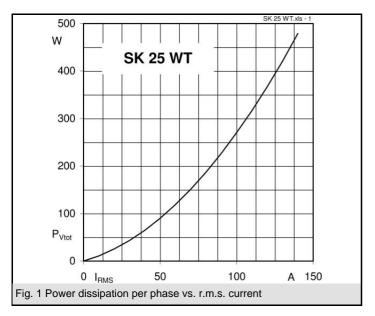
- Soft starters
- Light control (studios, theaters...)
- Temperature control

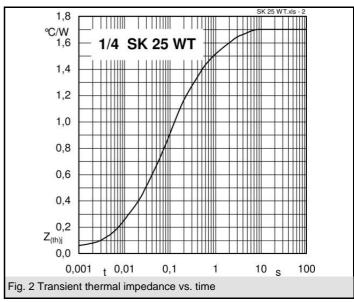
| V _{RSM} V | V _{RRM} , V _{DRM} | I _{RMS} = 29 A A (full conduction) (T _s = 85 °C) |
|-----------------------|-------------------------------------|---|
| 900 | 800 | SK 25 WT 08 |
| 1300 | 1200 | SK 25 WT 12 |
| 1700 | 1600 | SK 25 WT 16 |

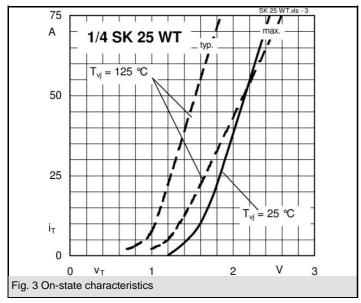
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | Symbol | Conditions | Values | Units |
|--|-----------------------|---|------------------|-------|
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | I _{RMS} | W1C ; sin. 180° ; T _s = 100°C | 20 | Α |
| $ \begin{array}{cccccccccccccccccccccccccccccccccccc$ | | W1C ; sin. 180° ; T _s = 85°C | 29 | Α |
| $ \begin{array}{cccccccccccccccccccccccccccccccccccc$ | I _{TSM} | T _{vi} = 25 °C ; 10 ms | 320 | Α |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | | T _{vi} = 125 °C ; 10 ms | 280 | Α |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | i²t | $T_{vj} = 25 ^{\circ}\text{C} \; ; 8,310 \text{ ms}$ | 510 | A²s |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | | T _{vj} = 125 °C ; 8,310 ms | 390 | A²s |
| $ \begin{array}{cccccccccccccccccccccccccccccccccccc$ | V _T | | max. 2,45 | |
| $ \begin{array}{cccccccccccccccccccccccccccccccccccc$ | $V_{T(TO)}$ | $T_{vj} = 125 ^{\circ}C$ | I - | V |
| $ \begin{array}{cccccccccccccccccccccccccccccccccccc$ | r_{T} | T _{vj} = 125 °C | max. 20 | mΩ |
| $ \begin{array}{cccccccccccccccccccccccccccccccccccc$ | $I_{DD};I_{RD}$ | | max. 8 | mA |
| $ \begin{array}{cccccccccccccccccccccccccccccccccccc$ | t _{gd} | 1 , | 1 | μs |
| $ \begin{array}{cccccccccccccccccccccccccccccccccccc$ | t_{gr} | | 1 | μs |
| $ \begin{array}{cccccccccccccccccccccccccccccccccccc$ | (dv/dt) _{cr} | | | V/µs |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | | | | A/µs |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | t_q | | 80 | μs |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | I _H | ") | 80 / 150 | mA |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | I_{L} | ļ ·, | 150 / 300 | mA |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | V_{GT} | | min. 2 | V |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | I_{GT} | | min. 100 | mA |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | V_{GD} | T_{vj} = 125 °C; d.c. | max. 0,25 | V |
| $ \begin{array}{cccccccccccccccccccccccccccccccccccc$ | I_{GD} | T _{vj} = 125 °C; d.c. | max. 3 | mA |
| Sin 180° per thyristor 1,78 K/W Rth(j-s) cont. per W1C 0,85 K/W T _{vj} -40 +125 °C T _{stg} -40 +125 °C T _{solder} terminals, 10s 260 °C V _{isol} a. c. 50 Hz; r.m.s.; 1 s / 1 min. 3000 / 2500 V~ M _s Mounting torque to heatsink 2,5 Nm M _t a m/s² m 19 g | R _{th(i-s)} | cont. per thyristor | 1,7 | K/W |
| Indicates sin 180° per W1C 0,89 K/W T _{vj} -40 +125 °C T _{stg} -40 +125 °C T _{solder} terminals, 10s 260 °C V _{isol} a. c. 50 Hz; r.m.s.; 1 s / 1 min. 3000 / 2500 V~ M _s Mounting torque to heatsink 2,5 Nm M _t a m/s² m 19 g | . 0 ., | sin 180° per thyristor | 1,78 | K/W |
| Sin 180° per W1C | $R_{th(j-s)}$ | · | 0,85 | K/W |
| T _{stg} | | sin 180° per W1C | l ´ | |
| T _{solder} terminals, 10s 260 °C V _{isol} a. c. 50 Hz; r.m.s.; 1 s / 1 min. 3000 / 2500 V~ M _s Mounting torque to heatsink 2,5 Nm M _t a m 19 g | T_{vj} | | | |
| V _{isol} a. c. 50 Hz; r.m.s.; 1 s / 1 min. 3000 / 2500 V~ M _s Mounting torque to heatsink 2,5 Nm M _t Nm Nm Nm a 19 g | T_{stg} | | -40 + 125 | |
| V _{isol} a. c. 50 Hz; r.m.s.; 1 s / 1 min. 3000 / 2500 V~ M _s Mounting torque to heatsink 2,5 Nm Nm Nm nm m 19 g | T _{solder} | terminals, 10s | 260 | °C |
| M _s Mounting torque to heatsink 2,5 Nm M _t Nm Nm Nm a m 19 g | V _{isol} | a. c. 50 Hz; r.m.s.; 1 s / 1 min. | 3000 / 2500 | V~ |
| m m/s² g | M_s | Mounting torque to heatsink | 2,5 | Nm |
| m 19 g | M_t | | | |
| | а | | | m/s² |
| Case SEMITOP® 2 T 37 | m | | 19 | g |
| | Case | SEMITOP® 2 | T 37 | |

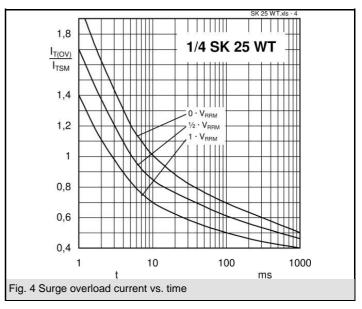


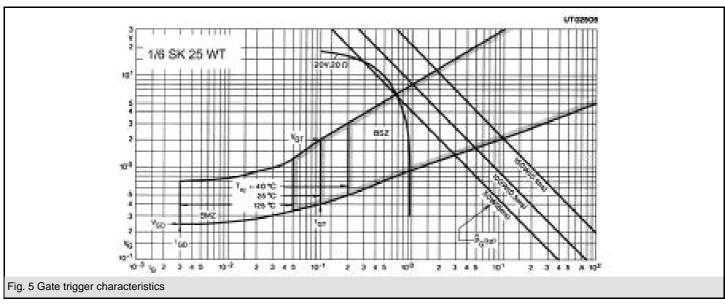
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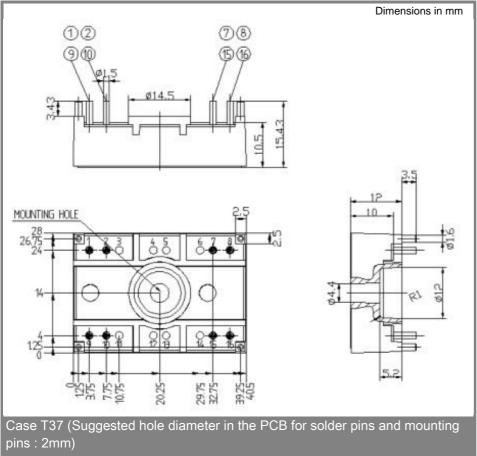


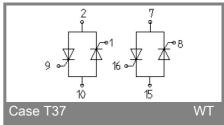












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